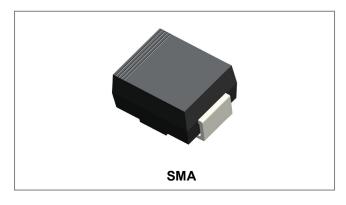






# **SK33A SCHOTTKY RECTIFIER**



### **Features**

- Small foot print, surface mountable
- Very low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term
- reliability
- Green products in compliance the ROHS directive
- This is a Pb Free device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

# **Circuit Diagram**



## **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

# **Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	-	30	V
Average Rectified Forward Current	I <sub>F (AV)</sub>	50% duty cycle @T <sub>A</sub> =75°C, rectangular wave form	3	А
Peak One Cycle Non-Repetitive Surge Current	I <sub>FSM</sub>	8.3ms, Half Sine pulse, T <sub>c</sub> = 25 °C	100	Α

## **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	$V_{F1}$	@ 3A, Pulse, T <sub>J</sub> = 25 °C	0.53	0.55	V
Reverse Current*	I <sub>R1</sub>	$@V_R = \text{rated } V_{R}, T_J = 25 ^{\circ}\text{C}$	0.015	1.0	mA
	I <sub>R2</sub>	$@V_R = \text{rated } V_{R_i} T_J = 100 ^{\circ}\text{C}$	3	20	mA
Junction Capacitance	Ст	$@V_R = 5V, T_C = 25  ^{\circ}C, f_{SIG} = 1MHz$	300	350	pF
Series Inductance	Ls	Measured lead to lead 5 mm from package body	8.0	-	nH
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%



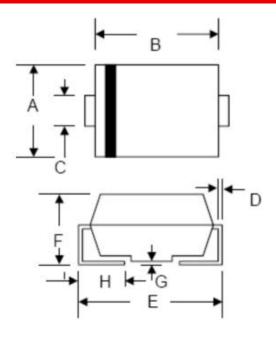




# **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to +150	°C
Typical Thermal Resistance Junction to Ambient	$R_{ heta JA}$	DC operation	55	°C/W
Approximate Weight	wt	-	0.06	g

### **Mechanical Dimensions SMA**



SYMBOL	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
А	2.40	2.84	0.094	0.112	
В	3.99	4.75	0.157	0.187	
С	1.05	1.70	0.041	0.067	
D	0.15	0.51	0.006	0.020	
E	4.80	5.66	0.189	0.223	
F	1.90	2.95	0.075	0.116	
G	0.05	0.203	0.002	0.008	
Н	0.76	1.52	0.030	0.600	

## **Ordering Information**

Device	Package	Shipping
SK33A	SMA	5000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

## **Marking Diagram**



Where XXXXX is YYWWL

SK = Device Type
3 = Forward Current (3A)
3 = Reverse Voltage (30V)
A = Package type
YY = Year

A = Package type
YY = Year
WW = Week
L = Lot Number

**Cautions:** Molding resin Epoxy resin UL:94V-0

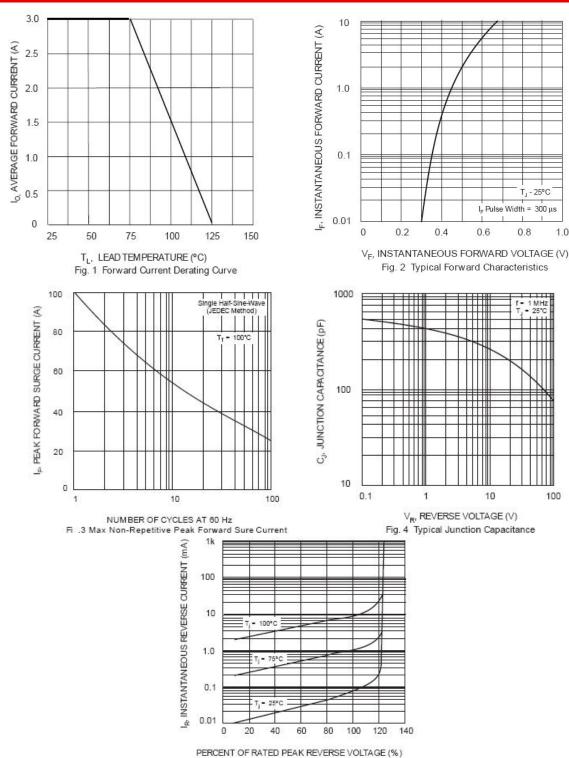
- China Germany Korea Singapore United States •
- http://www.smc-diodes.com sales@ smc-diodes.com •







# **Ratings and Characteristics Curves**



• China - Germany - Korea - Singapore - United States •

Fig. 5 Typical Reverse Characteristics

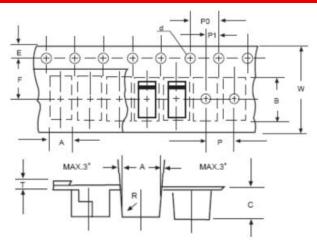
• http://www.smc-diodes.com - sales@ smc-diodes.com •







## **Carrier Tape Specification SMA**



SYMBOL	Millimeters		
STWIBOL	Min.	Max.	
Α	2.97	3.17	
В	5.70	5.90	
С	2.32	2.52	
d	1.40	1.60	
Е	1.40	1.60	
F	5.60	5.70	
Р	3.90	4.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	0.25	0.35	
W	11.80	12.20	

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